

STL105N4LF7AG

Automotive-grade N-channel 40 V, 3.0 mΩ typ., 105 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

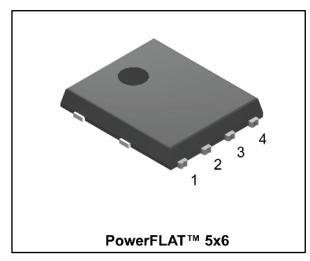
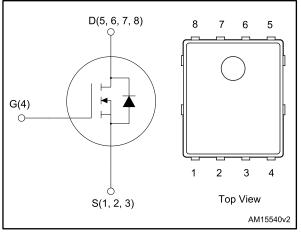


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	
STL105N4LF7AG	40 V	$4.5~\text{m}\Omega$	105 A	

AEC-Q101 qualified



- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STL105N4LF7AG	105N4LF7	PowerFLAT [™] 5x6	Tape and reel

Contents STL105N4LF7AG

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STL105N4LF7AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	40	V	
V_{GS}	Gate-source voltage	± 20	V	
ΙD	Drain current (continuous) at T _C = 25 °C	105	Α	
ΙD	Drain current (continuous) at T _C = 100 °C 74		Α	
I _{DM} ⁽¹⁾	Drain current (pulsed) 420		Α	
Ртот	Total dissipation at T _C = 25 °C	94	W	
Tj	Operating junction temperature range	EE to 17E	°C	
T _{stg}	Storage temperature range	-55 to 175 °C		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.6	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	32	°C/W

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

Electrical characteristics STL105N4LF7AG

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On/Off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1$ mA, $V_{GS} = 0$ V	40			>
IDSS	Zero gate voltage drain current	V _{GS} = 0 V V _{DS} = 40 V			10	μΑ
Igss	Gate-body leakage current	V _{GS} = ± 20 V, V _{DS} = 0 V			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5		2.5	V
D-ac	Static drain-source	V _G S = 10 V, I _D = 11.5 A		3.0	4.5	mΩ
R _{DS(on)}	on-resistance	$V_{GS} = 4.5 \text{ V}, I_D = 11.5 \text{ A}$		4.0	8.0	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1500	ı	pF
Coss	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	400	ı	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	50	-	pF
Qg	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 23 \text{ A},$	-	23.3	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V	-	5.5	-	nC
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	3.8	•	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 32 \text{ V}, I_D = 11.5 \text{ A},$	-	10	-	ns
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	6.5	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching	-	43	-	ns
t _f	Fall time	times" and Figure 18: "Switching time waveform")	-	15	-	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		105	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		420	Α
V _{SD} ⁽²⁾	Source-drain current	I _{SD} = 23 A, V _{GS} = 0 V	-		1.3	V
t _{rr}	Reverse recovery time	$I_{SD} = 23 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	32		ns
Qrr	Reverse recovery charge	V _{DD} = 32 V (see Figure 15: "Test circuit for	-	27		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	1.7		Α

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area GIPG061220171030SOA 10^{2} t_o=10 μs 10¹ t_o=100 μs 10⁰ T_i≤175 °C t₀=1 ms T_c= 25°C single pulse t_s=10 ms 10-10-1 10⁰ 10¹ $\vec{V}_{DS}(V)$

Figure 3: Thermal impedance $K = \frac{GADG1912201615432TH}{\delta = 0.5}$ 0.2
0.1
0.05
0.01 $\frac{Z_{t_{p}} = k^{*}R_{t_{h}}}{\delta = t_{p}/T}$ 10-5
10-4
10-3
10-2 t_{p} (s)

Figure 4: Output characteristics

GIPG061220171227OCH

80

VGS= 5, 6, 7, 8, 9, 10 V

60

VGS= 4 V

0

1

20

VGS= 3 V

0

1

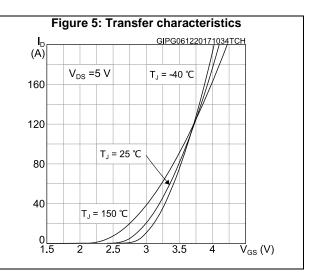
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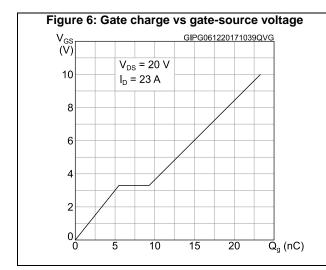
3

4

5

VDS (V)





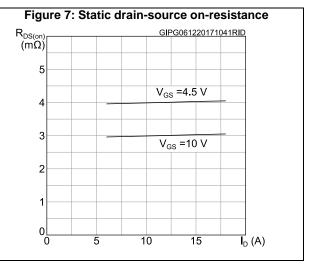
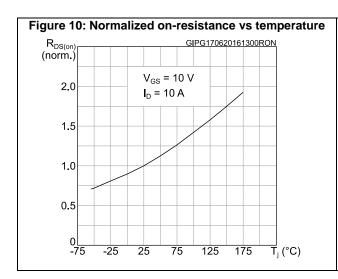
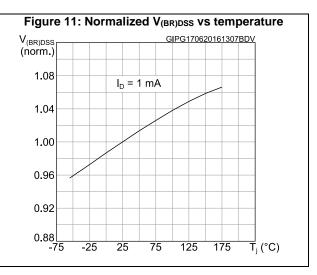
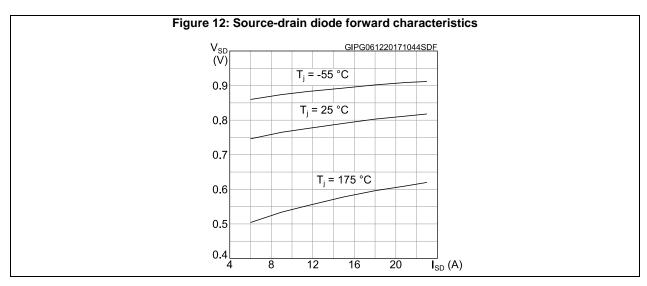


Figure 9: Normalized gate threshold voltage vs temperature V_{GS(th)} (norm.) GIPG170620161302VTH 1.2 $I_D = 250 \, \mu A$ 1.0 8.0 0.6 0.4 0.2 -25 25 75 125 175 T_i (°C)







Test circuits STL105N4LF7AG

3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 14

Figure 14

Figure 14

AM01468v1

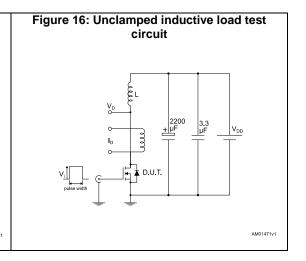
Figure 14: Test circuit for gate charge behavior

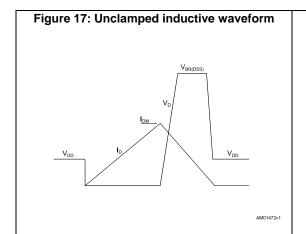
12 V 47 kΩ 100 nF D.U.T.

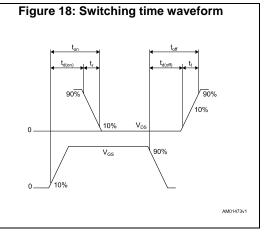
2200 VG

AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







Package information 4

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

PowerFLAT 5x6 WF type C package information 4.1

BOTTOM VIEW D6 D3 5 6 E7 63 E2 Detail A E3 Scale 3:1 80.0 D5(x4) L(x4) b(x8) e(x6) D4 SIDE VIEW Ā Detail ŏ TOP VIFW 8231817_WF_typeC_r15

Figure 19: PowerFLAT™ 5x6 WF type C package outline

Table 8: PowerFLAT™ 5x6 WF type C mechanical data

		mm	
Dim.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
е		1.27	
Е	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.05		1.35
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
θ	0°		12°

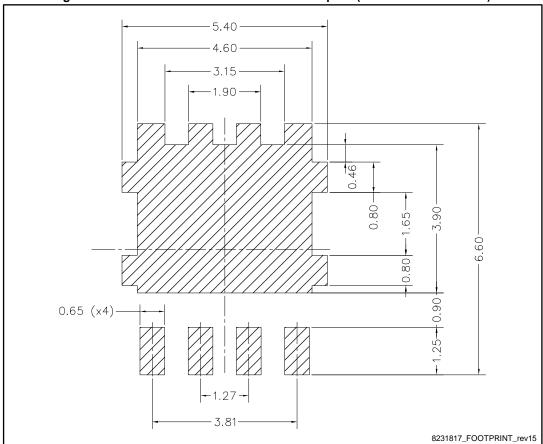


Figure 20: PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

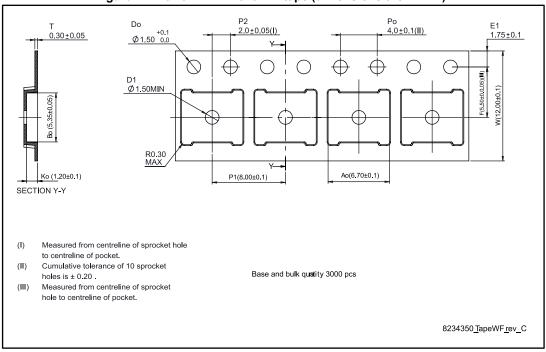
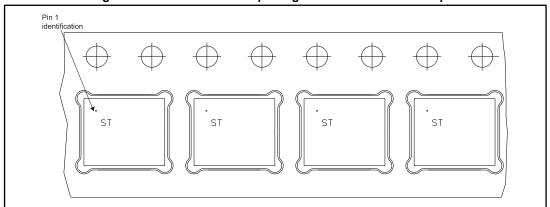


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



STL105N4LF7AG Package information

PART NO.

R25.00

R25.

Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)

Revision history STL105N4LF7AG

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
02-May-2016	1	First release.
13-Sep-2016	2	Updated Section 5: "Electrical characteristics".
18-Dec-2017	3	Datasheet promoted from preliminary data to production data. Modified Table 4: "On/Off states", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Minor text changes.
18-Jan-2018	4	Updated Figure 2: "Safe operating area" and Figure 3: "Thermal impedance".

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